

Electronic Filing System (EFS) Data
Electronic Patent Application Submission
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EFS ID: 53407

Application ID: 10675258



Title of Invention: Aluminum Pad Power Bus and
Signal Routing for Integrated
Circuit Devices Utilizing Copper
Technology Interconnect
Structures

First Named Inventor: Seung Kang

Domestic/Foreign Application: Domestic Application

Filing Date: 2003-09-30

Effective Receipt Date: 2004-01-09

Submission Type: Information Disclosure
Statement

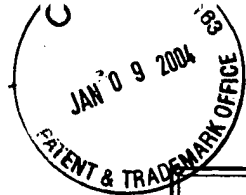
Filing Type:

Confirmation number: 4017

Attorney Docket Number: 075903-218

Total Fees Authorized:


Digital Certificate Holder: cn=John L. DeAngelis,ou=Registered Attorneys,ou=Patent and
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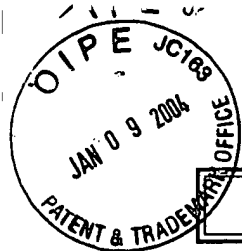


TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0


Title of Invention	Aluminum Pad Power Bus and Signal Routing for Integrated Circuit Devices Utilizing Copper Technology Interconnect Structures									
<p>Application Number: 10/675258 </p> <p>Date: 2003-09-30</p> <p>First Named Applicant: Seung H. Kang</p> <p>Confirmation Number: 4017</p> <p>Attorney Docket Number: 075903-218</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>John L. DeAngelis Jr. Registered Number: 30,622</td><td>/John L. DeAngelis, Jr./</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	John L. DeAngelis Jr. Registered Number: 30,622	/John L. DeAngelis, Jr./	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>Agere218-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	Agere218-usidst.xml		us-ids.dtd		us-ids.xsl
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Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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<p>Application Number: 10/675258 </p> <p>Confirmation Number: 4017</p> <p>First Named Applicant: Seung Kang</p> <p>Attorney Docket Number: 075903-218</p> <p>Art Unit: 2816</p> <p>Search string: (5148263 or 6225207).pn.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>5148263</td><td>1992-09-15</td><td>Hamai</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>6225207</td><td>2001-05-01</td><td>Parikh</td><td></td><td></td><td></td></tr></tbody></table> <p>Signature</p> <table border="1"><thead><tr><th>Examiner Name</th><th>Date</th></tr></thead><tbody><tr><td></td><td></td></tr></tbody></table>		init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	5148263	1992-09-15	Hamai					2	6225207	2001-05-01	Parikh				Examiner Name	Date		
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